

SMCG Plastic-Encapsulate Diodes

Schottky Rectifier

Features

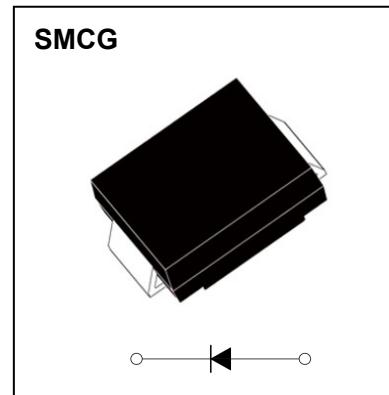
- I_o 5A
- VR_{RM} 100V
- High surge current capability
- Polarity: Color band denotes cathode
- Low V_f

Applications

- Rectifier

Marking

- SS510LS



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	SS510LS
Repetitive Peak Reverse Voltage	V _{RRM}	V		100
Maximum RMS Voltage	V _{RMS}	V		70
Average Forward Current	I _{F(AV)}	A	60Hz Half-sine wave, Resistance load, T _a =110°C	5.0
Surge(Non-repetitive)Forward Current	I _{FSM}	A	60Hz Half-sine wave, 1 cycle, T _a =25°C	150
Junction Temperature	T _J	°C		-55~+150
Storage Temperature	T _{STG}	°C		-55~+150

Electrical Characteristics (T_a=25°C Unless otherwise specified)

Item	Symbol	Unit	Test Condition		SS510LS
Peak Forward Voltage	V _F	V	IF=5A	T _a =25°C	0.6
Peak Reverse Current	I _{RRM1}	mA	V _{RM} =V _{RRM}	T _a =25°C	0.1
	I _{RRM2}			T _a =125°C	20
Thermal Resistance(Typical)	R _{θJ-A}	°C/W	Between junction and ambient		47
	R _{θJ-L}		Between junction and lead		13

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.3" x 0.3" (8.0 mm x 8.0 mm) copper pad areas

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

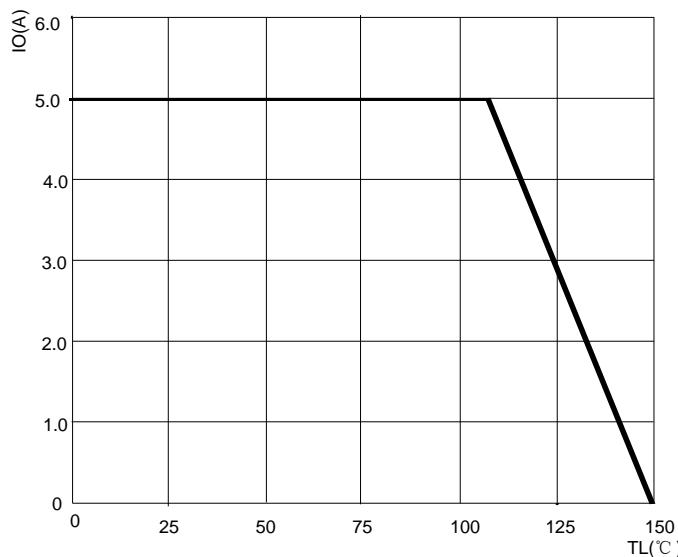


FIG.2: MAXIMUM NON-REPETITIVE FORWARD URGE CURRENT

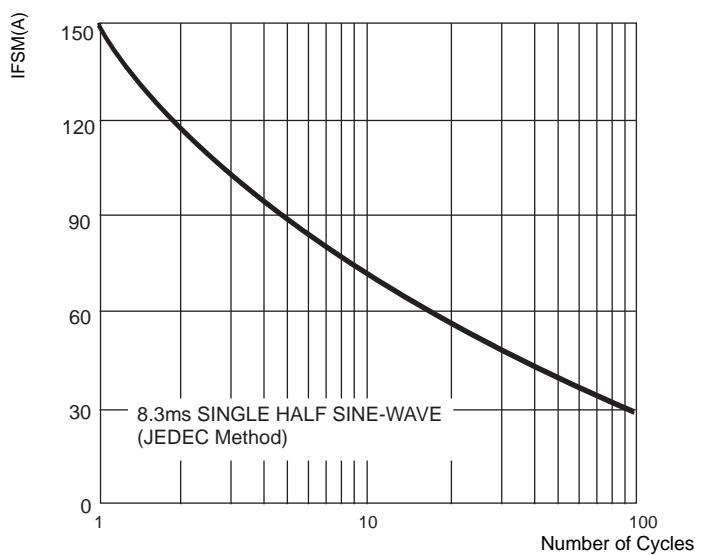


FIG.3: TYPICAL FORWARD CHARACTERISTICS

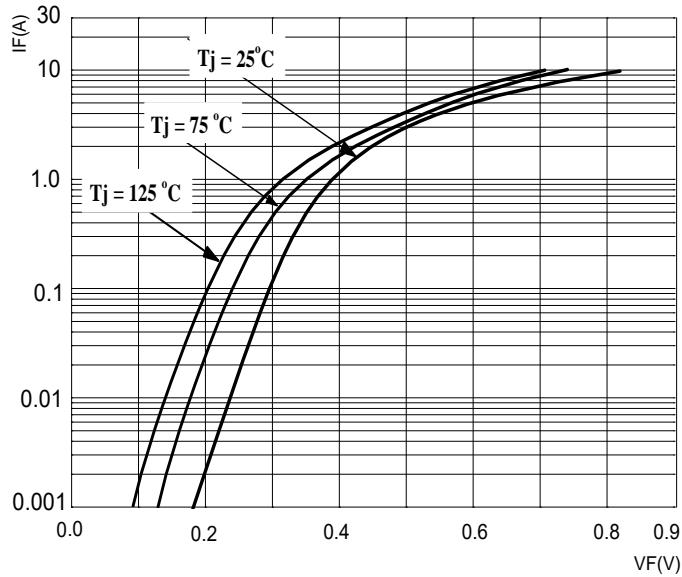
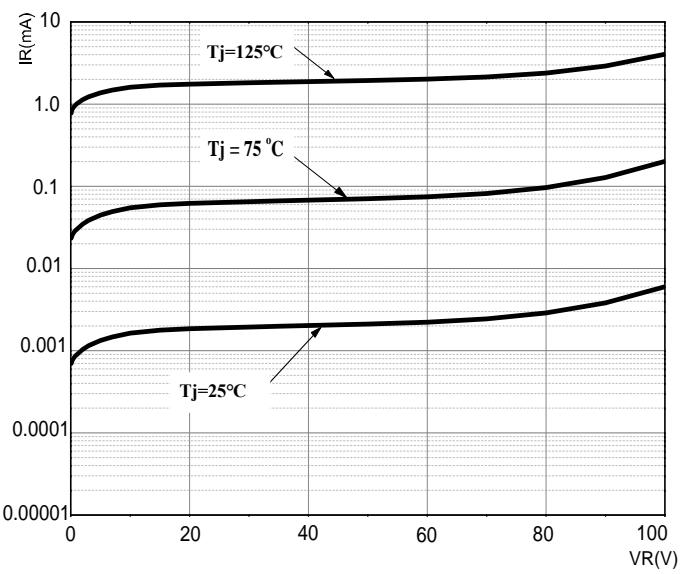
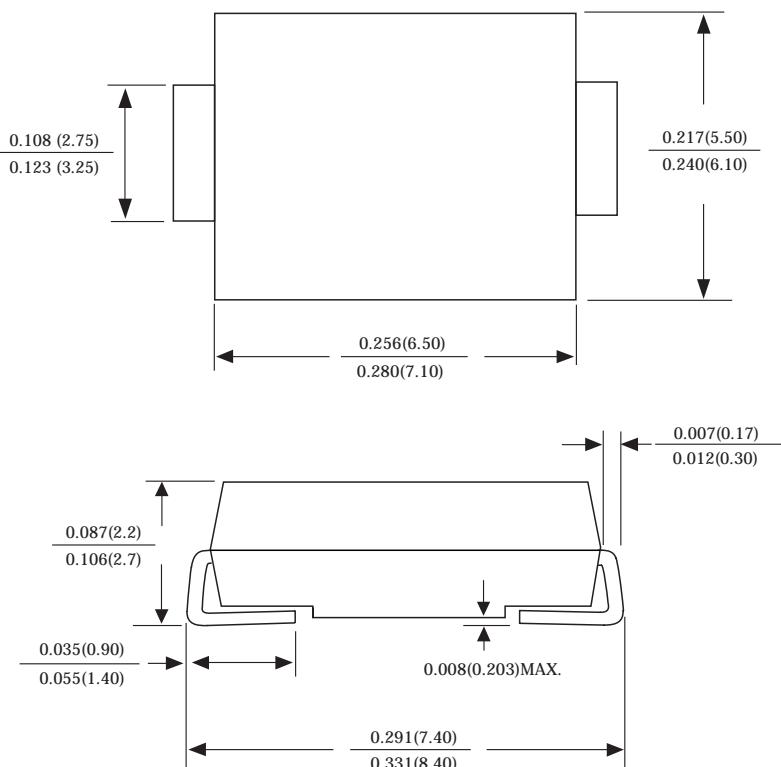


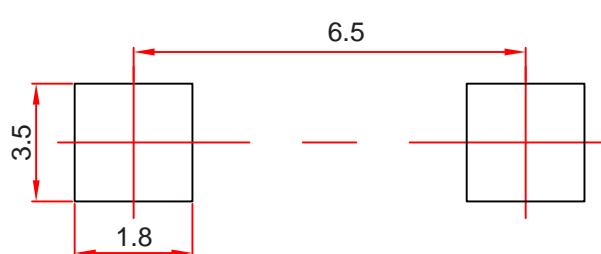
FIG.4: TYPICAL REVERSE CHARACTERISTICS



SMCG Package Outline Dimensions



SMCG Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

JSHD reserve the right to make modifications,enhancements, improvements, corrections or other changes without further notice to any product herein .JSHD does not assume any liability arising out of the application or use of any product described herein.

Reel Taping Specifications For Surface Mount Devices-SMCG

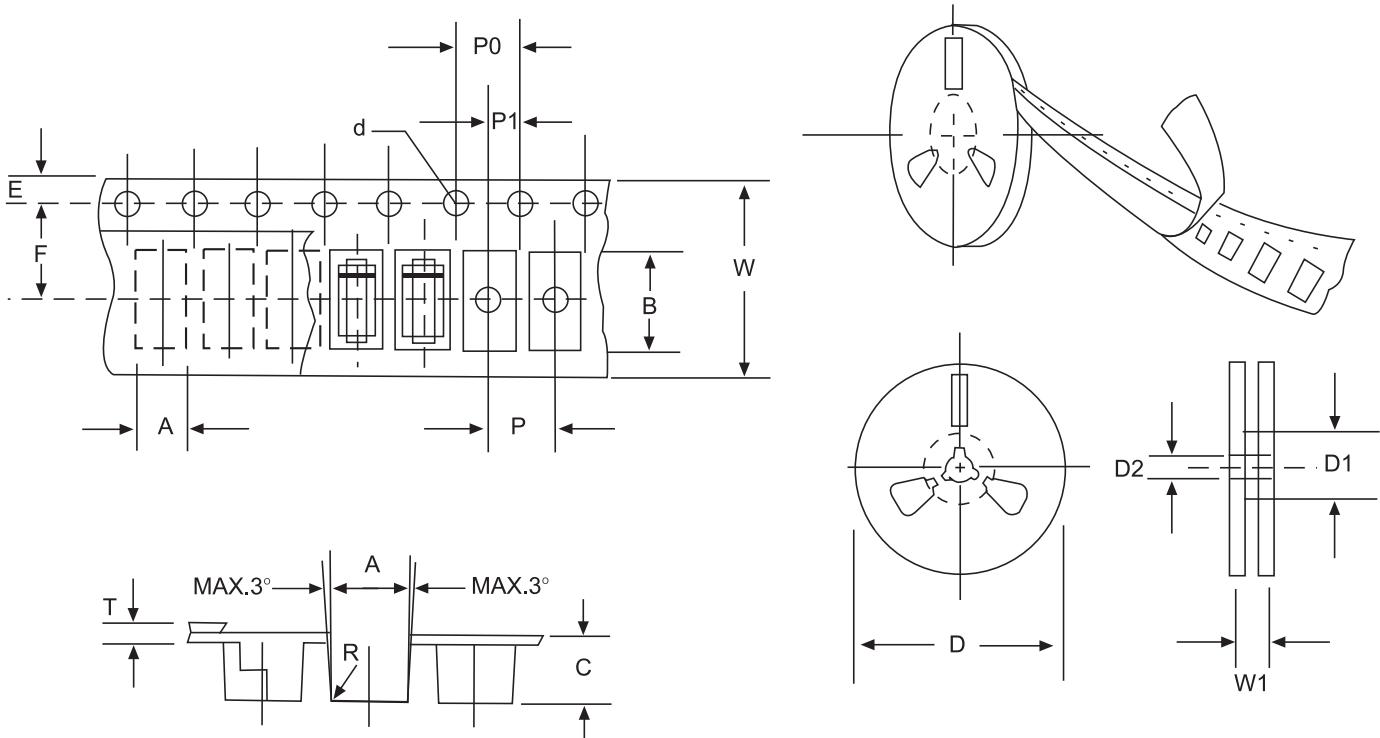


FIG : CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

ITEM	SYMBOL	SMCG mm(inch)
Carrier width	A	6.05 ± 0.1 (0.238 ± 0.004)
Carrier length	B	8.31 ± 0.1 (0.327 ± 0.004)
Carrier depth	C	2.70 ± 0.1 (0.106 ± 0.004)
Sprocket hole	d	1.55 ± 0.05 (0.061 ± 0.002)
Reel outside diameter	D	330 ± 2.0 (13 ± 0.079)
Reel inner diameter	D1	75 ± 1.0 (2.95 ± 0.039)
Feed hole diameter	D2	13 ± 0.5 (0.512 ± 0.020)
Stroket hole position	E	1.75 ± 0.1 (0.069 ± 0.004)
Punch hole position	F	7.65 ± 0.05 (0.301 ± 0.002)
Punch hole pitch	P	8.0 ± 0.1 (0.315 ± 0.004)
Sprocket hole pitch	P0	4.0 ± 0.1 (0.157 ± 0.004)
Embossment center	P1	2.0 ± 0.1 (0.079 ± 0.004)
Total tape thickness	T	0.3 ± 0.1 (0.012 ± 0.004)
Tape width	W	16.0 ± 0.2 (0.630 ± 0.008)
Reel width	W1	24.0 ± 2.0 (0.945 ± 0.079)

NOTE:Devices are packde in accordance with EIA standard RS-481-A and specification given above.